

February, 2009

# FPDB60PH60B

# **Smart Power Module for Front-End Rectifier**

### **General Description**

FPDB60PH60B is an advanced smart power module of PFC(Power Factor Correction) that Fairchild has newly developed and designed mainly targeting mid-power application especially for an air conditioners. It combines optimized circuit protection and drive IC matched to high frequency switching IGBTs. System reliability is futher enhanced by the integrated under-voltage lock-out and over-current protection function.

### **Features**

- Low thermal resistance due to AIN-DBC substrate
- 600V-60A 2-phase IGBT PWM semi-converter including a drive IC for gate driving and protection
- Typical switching frequency of 20kHz
- Isolation rating of 2500Vrms/min.

### **Applications**

• AC 180V ~ 264V single-phase front-end rectifier

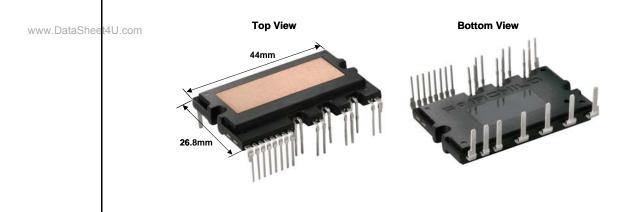


Fig. 1.

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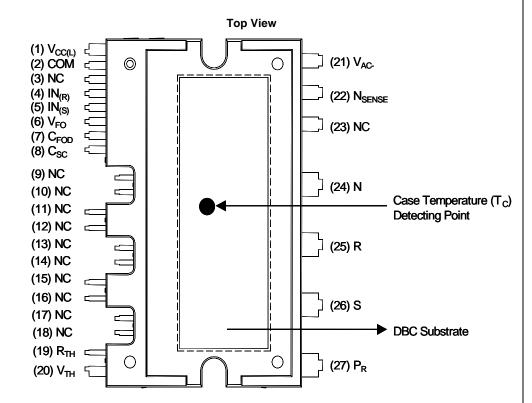
# **Integrated Power Functions**

• PFC converter for single-phase AC/DC power conversion (Please refer to Fig. 3)

# Integrated Drive, Protection and System Control Functions

- For IGBTs: Gate drive circuit, Overcurrent circuit protection (OC), Control supply circuit under-voltage (UV) protection
- Fault signaling: Corresponding to a UV fault
- Input interface: 5V CMOS/LSTTL compatible, Schmitt trigger input

# **Pin Configuration**



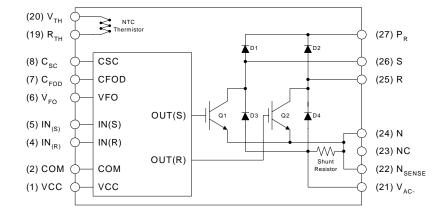
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Fig. 2.

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Pin Number	Pin Name	Pin Description
1	V <sub>CC</sub>	Common Bias Voltage for IC and IGBTs Driving
2	COM	Common Supply Ground
4	IN <sub>(R)</sub>	Signal Input for Low-side R-phase IGBT
5	IN <sub>(S)</sub>	Signal Input for Low-side S-phase IGBT
6	V <sub>FO</sub>	Fault Output
7	C <sub>FOD</sub>	Capacitor for Fault Output Duration Time Selection
8	C <sub>SC</sub>	Capacitor (Low-pass Filter) for Over Current Detection
19	R <sub>(TH)</sub>	NTC Thermistor terminal
20	V <sub>(TH)</sub>	NTC Thermistor terminal
21	V <sub>AC-</sub>	Current Sensing Terminal
22	N <sub>SENSE</sub>	Current Sensing Reference Terminal
24	N	Negative Rail of DC-Link
25	R	Output for R Phase
26	S	Output for S Phase
27	$P_{R}$	Positive Rail of DC-Link
3, 9~18, 23	NC	No Connection

# **Internal Equivalent Circuit and Input/Output Pins**



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Note:
1) Converter is composed of two IGBTs including four diodes and one IC which has gate driving and protection functions.

Fig. 3.

# **Absolute Maximum Ratings** (T<sub>J</sub> = 25°C, Unless Otherwise Specified) **Converter Part**

Item	Symbol	Condition	Rating	Unit
Supply Voltage	V <sub>i</sub>	Applied between R-S	264	$V_{RMS}$
Supply Voltage (Surge)	V <sub>i(Surge)</sub>	Applied between R-S	500	V
Output Voltage	V <sub>PN</sub>	Applied between P- N	450	V
Output Voltage (Surge)	V <sub>PN(Surge)</sub>	Applied between P- N	500	V
Collector-emitter Voltage	V <sub>CES</sub>		600	V
Each IGBT collector current	± I <sub>C</sub>	T <sub>C</sub> = 25°C	60	Α
Each IGBT collector current (Peak)	± I <sub>CP</sub>	T <sub>C</sub> = 25°C, Under 1ms pulse width	90	Α
Collector Dissipation	P <sub>C</sub>	T <sub>C</sub> = 25°C per One IGBT	178	W
Repetitive Peak Reverse Voltage	$V_{RRM}$		600	V
Peak Forward Surge Current	I <sub>FSM</sub>	Single half sine-wave	350	Α
Power Rating of Shunt Resistor	P <sub>RSH</sub>	T <sub>C</sub> < 125°C	2	W
Operating Junction Temperature	TJ	(Note 1)	-40 ~ 150	°C

# **Control Part**

Item	Symbol	Condition	Rating	Unit
Control Supply Voltage	V <sub>CC</sub>	Applied between V <sub>CC</sub> - COM	20	V
Input Signal Voltage	V <sub>IN</sub>	Applied between IN - COM	-0.3~17	V
Fault Output Supply Voltage	$V_{FO}$	Applied between V <sub>FO</sub> - COM	-0.3~V <sub>CC</sub> +0.3	V
Fault Output Current	I <sub>FO</sub>	Sink Current at V <sub>FO</sub> Pin	5	mA
Current Sensing Input Voltage	V <sub>SC</sub>	Applied between C <sub>SC</sub> - COM	-0.3~V <sub>CC</sub> +0.3	V

# **Total System**

	Item	Symbol	Condition	Rating	Unit
	Module Case Operation Temperature	T <sub>C</sub>		-20 ~ 100	°C
www.DataShee	Storage Temperature	T <sub>STG</sub>		-40 ~ 150	°C
	Isolation Voltage	V <sub>ISO</sub>	60Hz, Sinusoidal, AC 1 minute, Connection Pins to DBC	2500	V <sub>rms</sub>

# **Thermal Resistance**

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Junction to Case Thermal	$R_{\theta(j-c)Q}$	IGBT	-	-	0.7	°C/W
Resistance	$R_{\theta(j-c)HD}$	High-side diode	-	-	1.5	°C/W
(Referenced to PKG center)	$R_{\theta(j\text{-}c)LD}$	Low-side diode	-	-	0.85	°C/W

#### Note:

2. For the measurement point of case temperature( $T_{\mbox{\scriptsize C}}$ ), please refer to Fig. 2.

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Note: 1. The maximum junction temperature rating of the power chips integrated within the SPM is  $150^{\circ}\text{C}(@T_{C} \le 100^{\circ}\text{C})$ . However, to insure safe operation of the SPM, the average junction temperature should be limited to  $T_{J(ave)} \le 125^{\circ}\text{C}$  ( $@T_{C} \le 100^{\circ}\text{C}$ ).

# Electrical Characteristics (T<sub>J</sub> = 25°C, Unless Otherwise Specified)

# **Converter Part**

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
IGBT saturation voltage	V <sub>CE(sat)</sub>	$V_{CC}$ =15V, $V_{IN}$ = 5V; $I_{C}$ =50A	-	2.0	2.5	V
High-side diode voltage	$V_{FH}$	I <sub>F</sub> = 50A	-	2.4	2.9	V
Low-side diode voltage	$V_{FL}$	I <sub>F</sub> = 50A	-	1.2	1.6	V
Switching Times	t <sub>ON</sub>	V <sub>PN</sub> = 400V, V <sub>CC</sub> = 15V, I <sub>C</sub> =60A	-	560	-	ns
	t <sub>C(ON)</sub>	V <sub>IN</sub> = 0V ↔ 5V, Inductive Load	-	270	-	ns
	t <sub>OFF</sub>	(Note 3)	-	520	-	ns
	t <sub>C(OFF)</sub>	(11010-0)	-	110	-	ns
	t <sub>rr</sub>		-	44	-	ns
	I <sub>rr</sub>		-	6.5	-	Α
Current sensing resistor	R <sub>SENSE</sub>		1.8	2.0	2.2	mΩ
Collector - emitter Leakage Current	I <sub>CES</sub>	V <sub>CE</sub> = V <sub>CES</sub>	-	-	250	μА

# **Control Part**

Item	Symbol	С	ondition	Min.	Тур.	Max.	Unit
Quiescent V <sub>CC</sub> Supply Current	I <sub>QCCL</sub>	V <sub>CC</sub> = 15V, IN = 0V	V <sub>CC</sub> - COM	-	-	26	mA
Fault Output Voltage	$V_{FOH}$	V <sub>SC</sub> = 0V, V <sub>FO</sub> Circui	t: 4.7kΩ to 5V Pull-up	4.5	-	-	V
	$V_{FOL}$	V <sub>SC</sub> = 1V, V <sub>FO</sub> Circui	t: 4.7kΩ to 5V Pull-up	-	-	0.8	V
Over Current Trip Level	V <sub>SC(ref)</sub>	V <sub>CC</sub> = 15V		0.45	0.5	0.55	V
Supply Circuit Under-	UV <sub>CCD</sub>	Detection Level		10.7	11.9	13.0	V
Voltage Protection	UV <sub>CCR</sub>	Reset Level		11.2	12.4	13.2	V
Fault-out Pulse Width	t <sub>FOD</sub>	C <sub>FOD</sub> = 33nF (Note 4	4)	1.4	1.8	2.0	ms
ON Threshold Voltage	V <sub>IN(ON)</sub>	Applied between IN -	COM	3.0	-	-	V
OFF Threshold Voltage	V <sub>IN(OFF)</sub>			-	-	0.8	V
Resistance of Thermistor	R <sub>TH</sub>	@ T <sub>C</sub> = 25°C (Note Fig. 9)		-	50	-	kΩ
		@ T <sub>C</sub> = 80°C (Note F	Fig. 9)	-	5.76	-	kΩ

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4. The fault-out pulse width t<sub>FOD</sub> depends on the capacitance value of C<sub>FOD</sub> according to the following approximate equation : C<sub>FOD</sub> = 18.3 x 10<sup>-6</sup> x t<sub>FOD</sub>[F]

# **Recommended Operating conditions**

ltem	Symbol	Condition	Min.	Тур.	Max.	Unit
Input Supply Voltage	V <sub>I</sub>	Applied between R - S	180	-	264	$V_{rms}$
Output Voltage	$V_{PN}$	Applied between P - N	-	280	400	V
Control Supply Voltage	V <sub>CC</sub>	Applied between V <sub>CC</sub> - COM	13.5	15	16.5	V
Control Supply Variation	dV <sub>CC</sub> /dt	Applied between IN - COM	-1	-	1	V/μs
PWM Input Signal	f <sub>PWM</sub>	$T_C \le 100$ °C, $T_J \le 125$ °C, Per IGBT	-	20	-	kHz

<sup>3.</sup> t<sub>ON</sub> and t<sub>OFF</sub> include the propagation delay time of the internal drive IC. t<sub>C(ON)</sub> and t<sub>C(OFF)</sub> are the switching time of IGBT itself under the given gate driving condition internally. For the detailed information, please see Fig. 4

# **Electrical Characteristics**

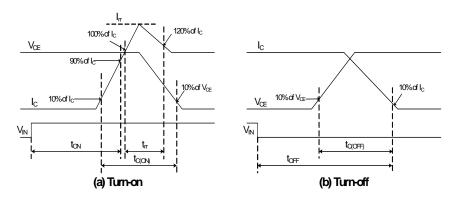


Fig. 4. Switching Time Definition

# **Mechanical Characteristics and Ratings**

Item	C	ondition		Limits		
nem	C	Min.	Тур.	Max.	Units	
Mounting Torque	Mounting Screw: - M3	Recommended 0.62N•m	0.51	0.62	0.72	N•m
Device Flatness	Note Fig. 5		0	-	+120	μ <b>m</b>
Weight			-	15.00	-	g

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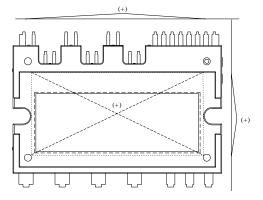
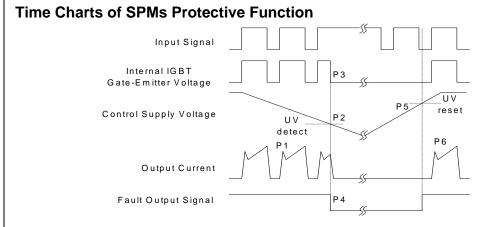


Fig. 5. Flatness Measurement Position

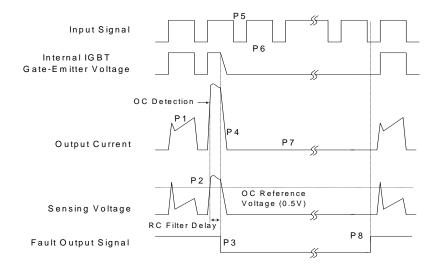


P1: Normal operation - IGBT ON and conducting current

P2 : Under voltage detection P3 : IGBT gate interrupt P4 : Fault signal generation P5 : Under voltage reset

P6: Normal operation - IGBT ON and conducting current

Fig. 6. Under-Voltage Protection



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P1 : Normal operation - IGBT ON and conducting current

P2 : Over current detection

P3: IGBT gate interrupt / Fault signal generation

P4: IGBT is slowly turned off

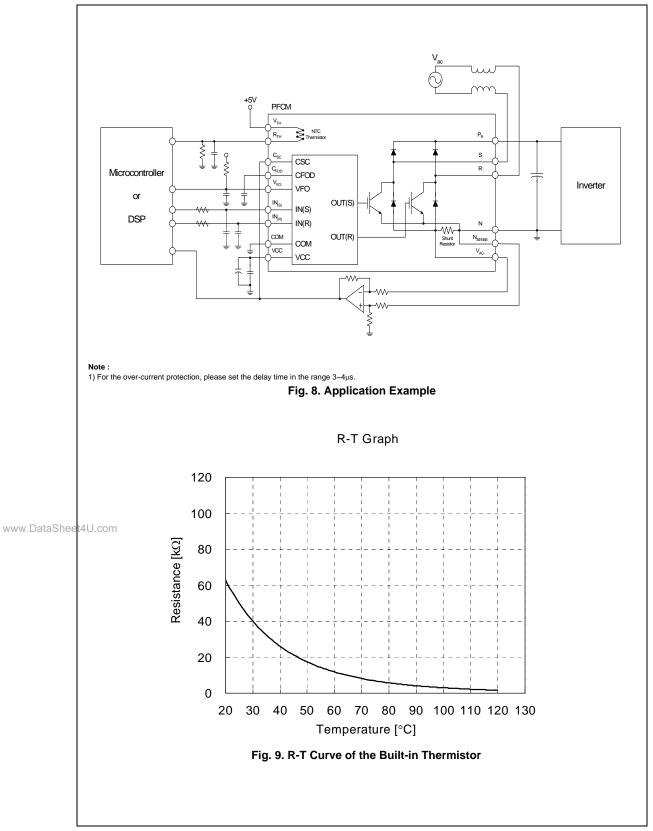
P5 : IGBT OFF signal

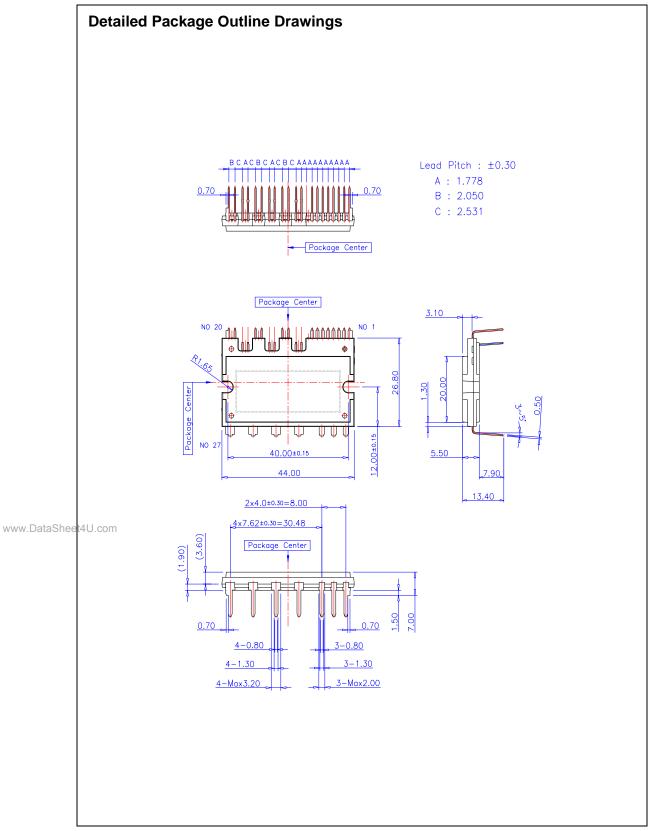
P6: IGBT ON signal - but IGBT cannot be turned on during the fault Output activation

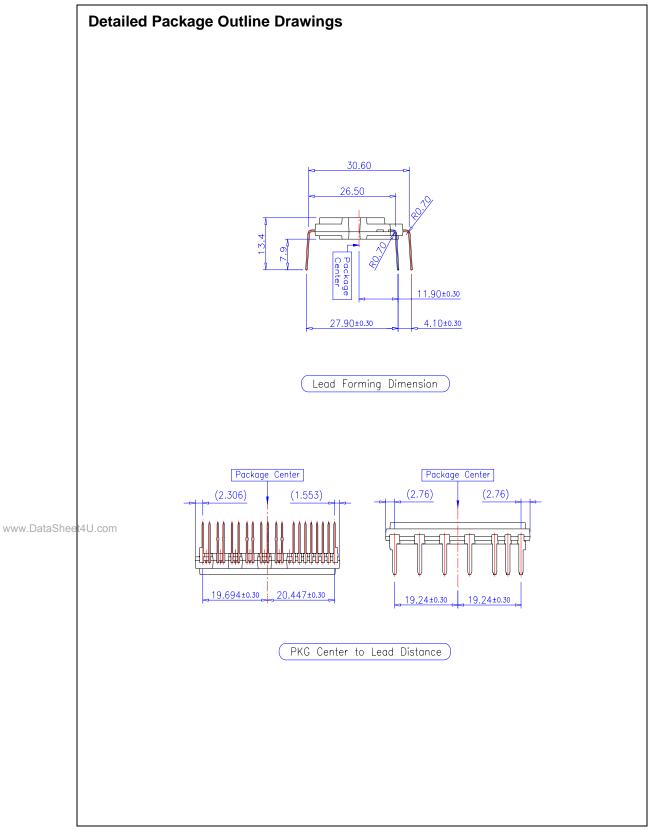
P7: IGBT OFF state

P8: Fault Output reset and normal operation start

Fig. 7. Over Current Protection







# **Detailed Package Outline Drawings** DETAIL LEAD LEAD TYPE 2 LEAD TYPE 3 LEAD TYPE 1 0.50±0.10 0.50±0.10 MAX0.85 MAX1.20 LEAD TYPE 2 LEAD TYPE 3 LEAD TYPE 1 SCALE 2 : 1 www.DataSheet4U.com LEAD TYPE 1 LEAD TYPE 2 LEAD TYPE 3 SCALE 5 : 1 LEAD SECTION X-X'

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